TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74HC592AP, TC74HC592AF**

#### 8-Bit Binary Counter with Input Register

The TC74HC592A is high speed CMOS 8-BIT REGISTER COUNTER fabricated with silicon gate  $\rm C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The internal counter counts at positive edge of Counter Clock (CCK) when Counter Clock Enable ( $\overline{\text{CCKEN}}$ ) is held "L" level. If Counter clear ( $\overline{\text{CCLR}}$ ) is held "L", the internal counter is cleared asynchronously to clock.

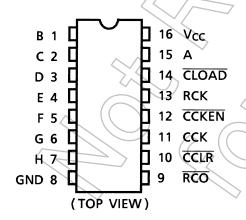
Input A to H are loaded to register at positive edge of Register Clock (RCK), and the register outputs are loaded to Counter when Counter Load  $(\overline{CLOAD})$  is held "L" level.

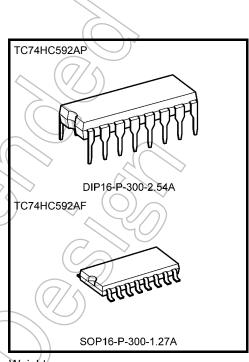
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $f_{max} = 35 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- $\bullet$  Output drive capability: 10 LSTTL loads for QA to QH
- Symmetrical output impedance: |IOH| = IOL = 4 mA (min)
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS592

### Pin Assignment



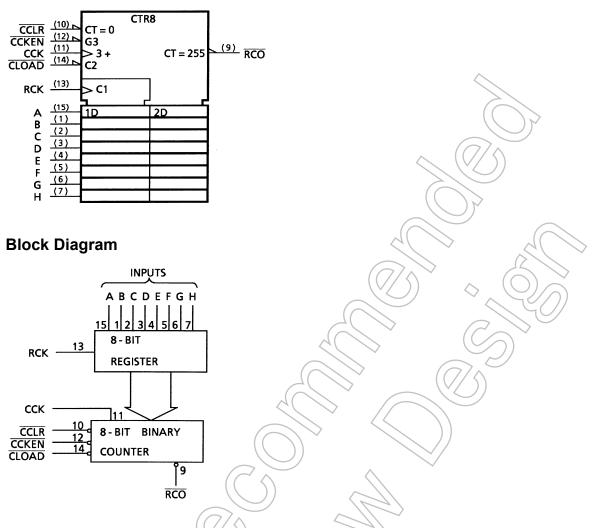


Weight

DIP16-P-300-2.54A: SOP16-P-300-1.27A: 1.00 g (typ.) 0.18 g (typ.)

Start of commercial production 1988-05

## **IEC Logic Symbol**



### **Truth Table**

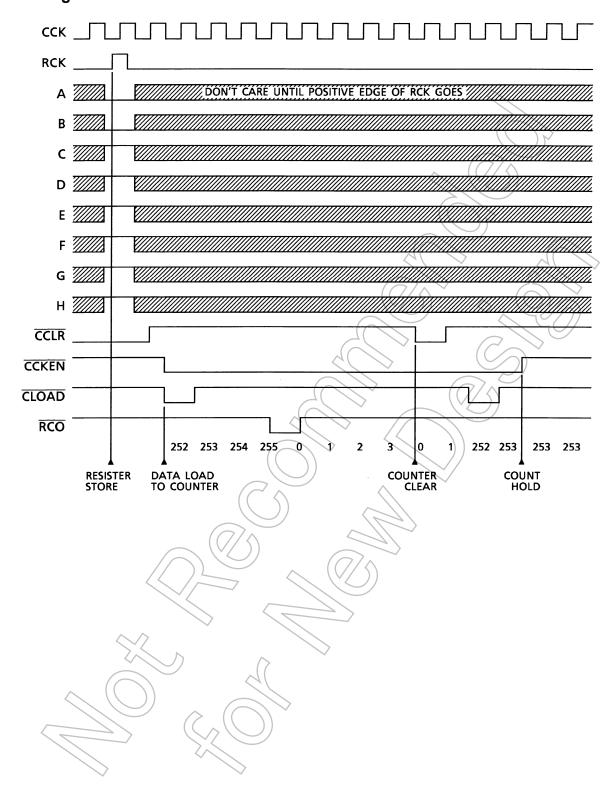
		Inputs	)		$\langle \langle \langle \rangle \rangle \rangle$
RCK	CLOAD	CCLR	CCKEN	ССК	Function
	CLOAD				
Х		Н	X	X	Register data is loaded into counter
Χ	н	// L	X	Χ	Counter clear
	X	$\langle \mathbf{x} \rangle$	Х	X	The data of A thru H inputs is stored into register
$ \rightarrow                                   $	X((	X	Х	X	Register state is not changed
Х	Á	<u> </u>	^ L (	$\mathcal{N}$	Counter advances the count
\( X =	7	Н	( ) (		No count
X	H	Н	H/	X	No count

X: Don't care

 $\overline{RCO} = \overline{QA' \cdot QB' \cdot QC' \cdot QD' \cdot QE' \cdot QF' \cdot QG' \cdot QH'}$ 

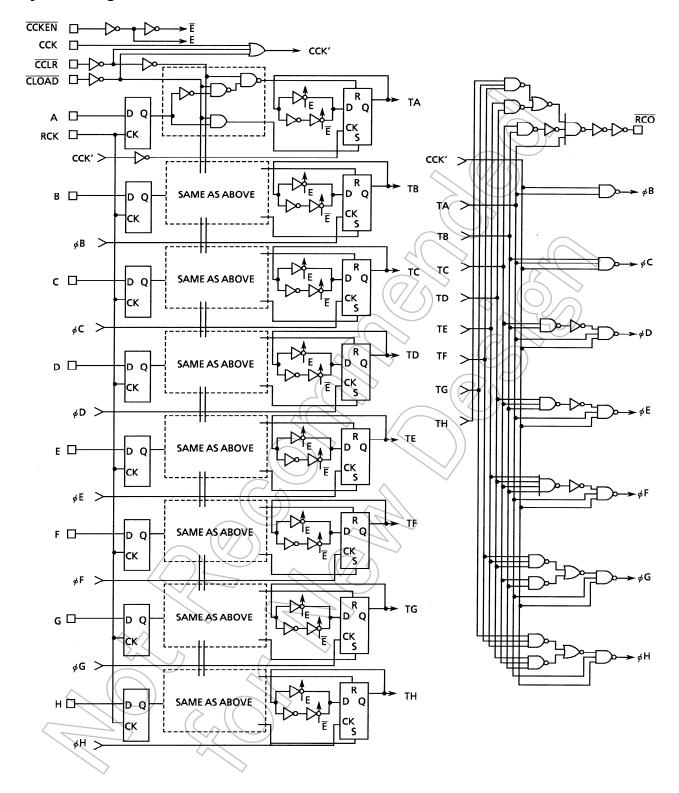
(QA' to QH': internal outputs of the counter)

### **Timing Chart**



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#### **System Diagram**



#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	−0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	−0.5 to V <sub>CC</sub> + 0.5	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	_mA
Power dissipation	P <sub>D</sub>	500 (DIP) (Note 2) / 180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	√ °C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	VCC	2 to 6	V
Input voltage	$//\sqrt{\hat{v}_{jN}}$	0 to V <sub>CC</sub>	٧
Output voltage	Vout	0 to V <sub>CC</sub>	٧
Operating temperature	Topr	40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.

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### **Electrical Characteristics**

### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
		_		2.0	1.50	_	4	1.50	_	
High-level input voltage	$V_{IH}$			4.5	3.15	_	7	3.15	_	V
				6.0	4.20	_	+	4.20	_	
				2.0	_	-/	0.50		0.50	
Low-level input voltage	$V_{IL}$	_		4.5	-<	/-((	1.35	_	1.35	V
Ŭ				6.0	_		1.80	_	1.80	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	Ι <sub>ΟΗ</sub> = -20 μΑ	2.0	1.9	2.0	>-	1.9		V
				4.5	4.4	4.5	_	4.4	_	
High-level output voltage	V <sub>OH</sub>			6.0	5.9	6.0	—	5.9	$\downarrow$	
			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31		4.13	<u> </u>	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	$\bigcirc -$ (	5.63	Š	
				2.0		0.0	0.1	74/	0.1	V
			I <sub>OL</sub> = 20 μA	4.5	>_	0.0	0.1	0.1	0.1	
Low-level output voltage	$V_{OL}$	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	4	6.0	_	0.0	91	) —	0.1	
			I <sub>OL</sub> = 4 mA	4.5	_	0.17	0.26	_	0.33	
			$I_{OL} = 5.2 \text{ mA}$	6.0		0.18	0.26	_	0.33	
Input leakage current	I <sub>IN</sub>	$V_{IN} = V_{CC}$ or $C$	SND	6.0		1	±0.1	_	±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_{CC}$ or $C$	AND	6.0	1	77	4.0		40.0	μА

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## Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Test Condition			Ta = -40 to 85°C	Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width	<b>5</b>		2.0	_	75	95	
(CCK, RCK)	t <sub>W (H)</sub>	_	4.5 <	_	15	19	ns
(CCK, RCK)	t <sub>W (L)</sub>		6.0		13	16	
Minimum mula a middle			2.0	( <i>F</i> )	100	125	
Minimum pulse width ( CCLR )	t <sub>W (L)</sub>	_	4.5		20	25	ns
(CCLR)		<	6.0	/ <del>()</del>	16	21	
Minimum pulse width			2.0		175	220	
(CLOAD)	t <sub>W (L)</sub>	_	4.5	> _	35	44	ns
(CLOAD)			6.0	_	30	37	
Minimum set-up time		41	2.0	_	75	95	
(CCKEN-CCK)	ts	-	4.5	- (	15	19	ns
(CCREN-CCR)		$( \langle //                                 $	6.0	-((	13	16	
Minimum set-up time			2.0	4	(150)	190	
(RCK-CLOAD)	ts	4	4.5	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	30	38	ns
(RCR-CLOAD)		4()	6.0		26	32	
Minimum set-up time			2.0		100	125	
(A to H-RCK)	ts		4.5	) —	20	25	ns
(A to THYON)		4()	6.0	_	17	21	
			2.0	_	5	5	
Minimum hold time	t <sub>h</sub> ((		4.5	_	5	5	ns
			6.0	_	5	5	
Minimum removal time	((		2.0	_	75	95	
(CCLR)	t <sub>rem</sub>	_ [[]]	4.5	_	15	19	ns
(OOLIV)	((// )		6.0	_	13	16	
Minimum removal time		~ ((7)\(\)	2.0		75	95	
(CLOAD)	trem		4.5	_	15	19	ns
(OLOND)			6.0		13	16	
			2.0	_	4	3.5	
Clock frequency	f	<b>───</b> -	4.5	_	22	18	MHz
	$\bigcirc$		6.0		26	21	



### AC Characteristics (C<sub>L</sub> = 15 pF, $V_{CC}$ = 5 V, Ta = 25°C, input: $t_r$ = $t_f$ = 6 ns)

Characteristics	Symbol	Test Condition		Тур.	Max	Unit
Output transition time	t <sub>TLH</sub>	_	_	6	12	ns
•	t <sub>THL</sub>					
Propagation delay time	t <sub>pLH</sub>			25	38	ns
(CCK-RCO)	t <sub>pHL</sub>			20	30	113
Propagation delay time	t <sub>pLH</sub>	CLOAD ="L"		39	60	ns
(RCK-RCO)	$t_{pHL}$	CLOAD - L		) 39	0	113
Propagation delay time	<b>+</b>			24	36	ns
( CCLR - RCO )	t <sub>pLH</sub>	_	J	24	30	115
Propagation delay time	t <sub>pLH</sub>		>	35	53	ns
(CLOAD - RCO)	t <sub>pHL</sub>			35	55	115
Maximum clock frequency	f <sub>max</sub>	-4( >>	25	35	X	MHz

# AC Characteristics ( $C_L = 50 \text{ pF}$ , input: $t_r = t_f = 6 \text{ ns}$ )

			\ \ V /	) )	$\overline{}$				
Characteristics	Symbol	Test Condition		9 -	Га = 25°C			a ⊨ 85°C	Unit
			VCC (V)	Min	Typ.	Max	Min	Max	
	<b>4</b> —		2.0	_	30	75)	_	95	
Output transition time	t <sub>TLH</sub>	- (	4.5	_	(8)	15	_	19	ns
	t <sub>THL</sub>		6.0		V1	13	_	16	
Propagation delay	<b></b>		2.0	-	94	220	_	275	
time	t <sub>pLH</sub>		4.5	_	29	44	_	55	ns
(CCK-RCO)	t <sub>pHL</sub>		6.0		24	37	_	47	
Propagation delay	<b></b>		2.0	_	160	340	_	425	
time	t <sub>pLH</sub>	CLOAD ="L"	4.5	_	45	68	_	85	ns
(RCK-RCO)	t <sub>pHL</sub>	77/^	6.0	> _	34	58	_	73	
Propagation delay			2.0	_	89	215	_	270	
time	t <sub>pLH</sub>	$\longrightarrow$ $\longleftarrow$ (//	4.5	_	28	43	_	54	ns
(CCLR - RCO)			6.0	_	22	37	_	46	
Propagation delay	t <sub>pLH</sub>		2.0	_	140	300	_	375	
time	·	7	4.5	_	40	60	_	75	ns
(CLOAD - RCO)	t <sub>pHL</sub>		6.0	_	30	51	_	64	
		$\mathcal{A}($	2.0	4	20	_	3.5	_	
Maximum clock frequency	f <sub>max</sub>		4.5	22	33	_	18	_	MHz
	$\wedge$		6.0	26	49	_	21		
Input capacitance	CIN			_	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)	<u> </u>		_	31	_	_	_	pF
. ~	(11010)	,							

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

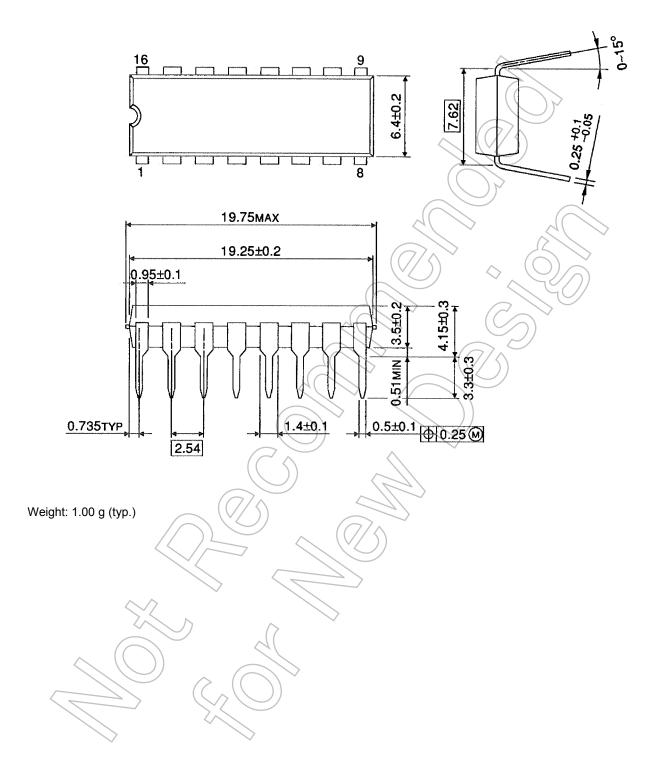
Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 



### **Package Dimensions**

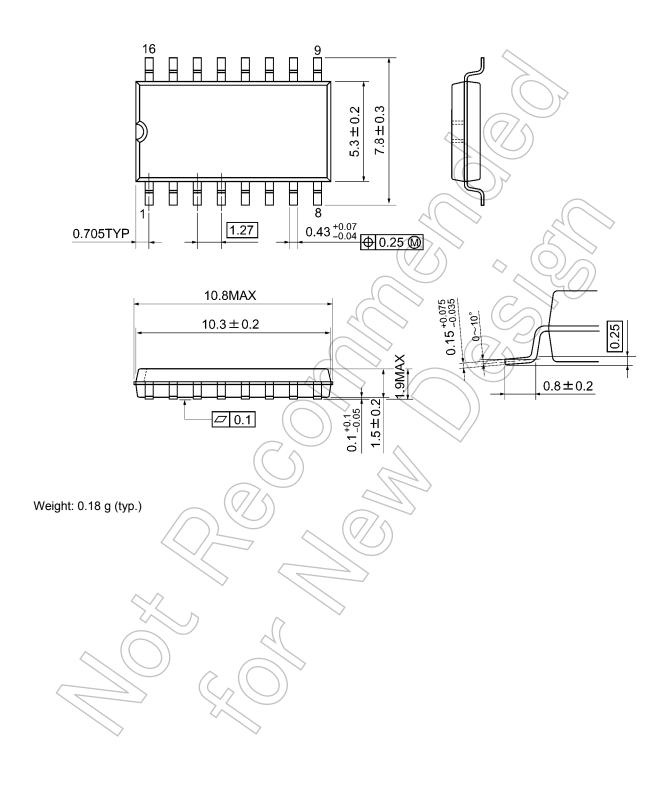
DIP16-P-300-2.54A Unit: mm





### **Package Dimensions**

SOP16-P-300-1.27A Unit: mm



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